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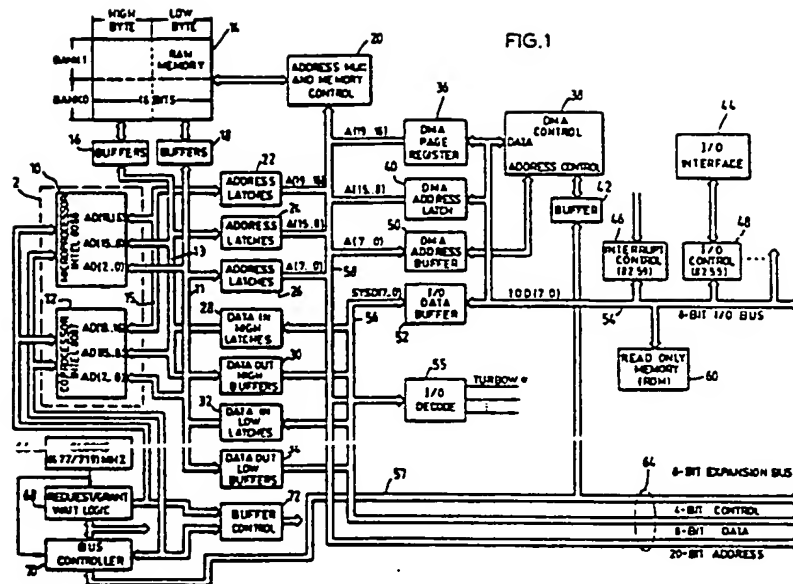
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(54) **Personal computer having normal and high speed execution modes.**

(57) A personal computer is disclosed having a high speed microprocessor which executes in either a FAST mode or a SLOW mode application programs written for a slow speed microprocessor. The slow speed microprocessor contains a pre-fetch queue that is smaller than the prefetch queue of the high speed microprocessor. A logic means is included, responsive to a mode select signal for controlling the wait state of said high speed microprocessor when in the SLOW speed mode so that every other word accessed to said RAM memory requires two consecutive word accesses to the same memory address to obtain the contents of the addressed location thereby enabling said high speed microprocessor to execute application programs in the SLOW mode, on the average, at substantially the same speed as the program normally runs on the slow speed microprocessor.

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PERSONAL COMPUTER HAVING NORMAL
AND HIGH SPEED EXECUTION MODES

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This invention relates to personal computers designed with commercially available microprocessor chip sets. More particularly, the present invention relates to a personal computer in which the central microprocessor is controlled to execute programs in a normal high speed mode or to execute at a slow speed mode to achieve software compatibility with existing application programs which, because of their specific hardware dependency, cannot be run at the higher speed.

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The introduction of the personal computer has resulted in a tremendous amount of application software programs written for both the professional and for the home entertainment market. These personal computers are designed around commercially available microprocessor chip sets which may include a plurality of microprocessors connected in an architecture which results in varying degrees of execution throughput rates.

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A very popular microprocessor chip set widely used by personal computer manufacturers is the Intel Corporation 8088 microprocessor which has its particular instruction set. The same instruction set is also available in a

different microprocessor from Intel, the 8086 microprocessor. The 8086 microprocessor has a substantially higher instruction execution cycle rate, almost twice as fast as the 8088. Available also from Intel is a coprocessor chip, the Intel 8087, which may be used either with the 8088 or the 8086 to achieve even higher execution throughput rates.

With the availability of a software compatible (i.e., executes the same instruction set) microprocessor, it is possible to upgrade a prior-art personal computer with higher execution speeds for some application programs written for the lower speed microprocessor chip set. While faster software compatible microprocessors are available, it is not possible, however, to simply substitute the faster microprocessor for the slower microprocessor and thereby produce a personal computer which executes at twice the speed all of the application programs written for the slower microprocessor.

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Not all application programs written for the slower microprocessor are capable of running at faster microprocessor execution speeds, even though each instruction in the program is executed the same in both machines. The inability to run some programs at higher speeds results from the fact that programmers, when writing for the slower microprocessor, take advantage of the particular execution cycle times in structuring routines which are time dependent. For example, video game programs rely upon the normal execution cycle times for the microprocessor in generating time intervals which are necessary for the program to perform its various functions. Running the program at higher instruction execution speeds change the resulting time intervals and thereby render the program non-functional. Application programs which are not dependent

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upon the execution speed typically can be run at these higher execution speeds and obtain the same results.

It is undeniable that providing a personal computer
5 capable of executing application programs written for a slower microprocessor in half the time would be of a commercial advantage in the marketplace, but such a device would not be competitive unless it were able to execute all the application programs written for that slow speed micro-
10 processor. For example, it is possible to provide a personal computer having an Intel 8086, 8087 microprocessor pair (a high speed microprocessor) rather than an 8088, 8087 microprocessor pair (a slow speed microprocessor) and run the high speed microprocessor at two different clocking
15 frequencies, one for a high speed mode for those application programs which can run at the high speed and one for a slow speed mode for those application programs which are time dependent. Unfortunately, this simple clocking change does not result in a personal computer which is software
20 compatible for all varieties of application programs.

Even though the two microprocessor chip sets, the 8086, 8088 are software compatible, the internal design of the microprocessors are not the same. This difference in
25 internal design, depending upon the design of the application program, i.e., does it contain a lot of program jumps, affects the execution speed of a given application program. The execution time at the high speed for the high speed microprocessor is not necessarily proportionally faster
30 than the execution time when the microprocessor clock is set to the slower normal frequency for the slow speed microprocessor. Stated differently, reducing the microprocessor clock from its high speed mode to the normal clock for the slow speed microprocessor while keeping all else
35 the same does not result in the same execution time for a given application program to run on the high speed micro-

processor as occurs if the same program is run on the slow speed microprocessor.

For the Intel 8086 microprocessor, simply reducing
5 the clocking frequency to the normal frequency of the 8088 microprocessor results in an execution speed which is faster than it would have been for the slow speed 8088 microprocessor chip. This faster execution speed results from the internal design difference which exists between
10 the two microprocessors, and the fact that the 8086 requires 16-bit fetches from memory while the 8088 requires 8-bit byte fetches.

The internal design difference between these two
15 microprocessors is primarily in the amount of pre-fetch buffer memory provided in the microprocessor. In the Intel 8088, there is four bytes of pre-fetch queue while in the 8086, there is six bytes of pre-fetch queue. Each microprocessor is designed to keep its pre-fetch queue full with
20 information in order that the microprocessor can continue to execute code, which on the average, achieves a desired execution throughput rate. When program jumps occur, the contents of the pre-fetch buffer are lost. This loss of information is reflected in wasted execution time because
25 of the time required to obtain the pre-fetch information that is thrown away. Thus, the 8088 microprocessor, having four bytes of pre-fetch queue running at a given clocking frequency and fetching 8-bit bytes per fetch cycle would produce a different execution throughput than the 8086,
30 having six bytes of pre-fetch queue running at the same clocking frequency but fetching 16-bit bytes per fetch cycle. It is because of this difference in the pre-fetch buffer capacity and the rate at which 8-bit bytes are fetched from memory that the 8086 runs at a faster speed
35 for the same application program when the 8086 micropro-

cessor is run at the same clocking frequency as is normally used for the 8088.

Therefore, it would be advantageous to provide a
5 personal computer which provides for a high speed micro-processor to execute application programs which are not time dependent at high speeds, but providing a lower normal speed execution of those application programs which are
10 time dependent so that the time dependent application programs appear to be running at substantially the same execution speed as they would have run on the micro-processor for which they were written.

In accordance with the present invention, there is
15 disclosed a personal computer having a high speed micro-processor that is responsive to a mode select signal for executing in either a fast mode or a slow mode, application programs written for a slow speed microprocessor. The slow speed microprocessor is software compatible with said high
20 speed microprocessor and has an internal pre-fetch queue with a first number of bytes of memory. The high speed microprocessor includes an internal pre-fetch queue with a second number of bytes of memory. The first number of bytes of pre-fetch queue in the slow speed microprocessor
25 is less than the second number of pre-fetch queue in the high speed microprocessor.

The personal computer further includes a RAM memory having each word comprised of a plurality of bytes, a clock
30 generator responsive to the mode select signal for generating the clocking signal to the high speed microprocessor such that in the slow mode, the clocking frequency is the same as the normal clocking frequency for the slow micro-processor and in the fast mode is higher than the clocking
35 frequency for the slow speed microprocessor.

The personal computer also includes a logic means responsive to the mode select signal and the clock generator for controlling the wait state of the high speed microprocessor when in the slow speed mode so that every
5 other word access to the RAM memory requires two consecutive word accesses to the same memory address to obtain the contents of the addressed location. In this manner, the high speed microprocessor executes the application programs in the slow mode, on the average, at substantially the same
10 speed as the program normally runs on the slow speed microprocessor.

For a fuller understanding of the present invention, reference should be had to the following
15 detailed description of the preferred embodiment of the invention taken in conjunction with the accompanying drawings in which:

FIGURE 1 is a functional block diagram of the
20 architecture of the present invention;

FIGURES 2, 3, and 4, when FIGURE 3 is placed to the right of FIGURE 2 and FIGURE 4 is placed below FIGURE 2, comprise a detail circuit diagram of a portion of the
25 architecture of the present invention shown in FIGURE 1, and includes the 8088 and 8087 microprocessor pair and the clock generation circuits;

FIGURES 5 and 6, when the latter is placed to the
30 right of the former, illustrates the RAM memory and address multiplexer and memory control logic as shown in FIGURE 1;

FIGURES 7 and 8, when the latter is placed to the right of the former, illustrates a detail circuit diagram
35 of the request/grant wait logic, the bus controller, and the buffer control as shown in FIGURE 1;

FIGURE 9 is a timing diagram for various signals of the present invention which occur during different cycle operations when the microprocessor chip set is operating in the FAST mode; and

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FIGURE 10 is a timing diagram of various cycle operations for the microprocessor chip set when operating in the SLOW mode.

10 Similar reference numerals refer to similar parts throughout the several views of the drawings.

Through the following detail description of the preferred embodiment of the present invention, and shown in
15 the accompanying drawings, the following notation has been adopted for indicating signals. Since the terms "1" or "0" and "true" or "false" can be ambiguous, their use is avoided. In their place the terms "logic high (H)" and "logic low (L)", in association with "active" and
20 "inactive" states for the signals have been used. An asterisk (*) following a signal name indicates that the signal is "active" when low. For example, the microprocessor 10 state control line SO* is active when at a logic low state, while the microprocessor 10 ready signal PRDY is
25 active when in a logic high state. The signals are "inactive" when in the logic state opposite to its "active" logic state. In our example, SO* is inactive when in the logic high state, and the signal PRDY is inactive when in the logic low state.

30

Certain logic circuit functions of the preferred embodiment of the present invention have been constructed using programmable array logic (PAL) chips in implementing the combinational logic required to combine certain ones of
35 the logic signals to obtain additional logic signals. For such devices, the combinational logic circuits implemented

with the PAL chips are neither shown in the drawings or discussed in the specification; however, the logic design data for producing each PAL chip contained in the invention and illustrated in the drawings is provided in this specification as an appendix entitled "Appendix for PAL Design Data". This design data presents the logic equations for combining the input signals to produce the output signals indicated in the drawings. For these design equations and the type of PAL chip to be programmed, it is possible to produce the particular chip using standard manufacturing techniques suggested by the PAL manufacturer.

Turning now to the Figures, and first to FIG. 1, there is shown a functional block diagram of the logic circuits of a personal computer in accordance with the present invention. The personal computer is designed around the central processing units comprised of microprocessor 10 and coprocessor 12 (hereinafter "microprocessor 2"). For the presently preferred embodiment of the invention, microprocessor 10 is the Intel Corporation 8086 microprocessor, and the coprocessor 12 is the Intel 8087 coprocessor.

Microprocessor 1 is a 16-bit microprocessor having addressing capability of 20 bits. As shown in FIG. 1, the address lines for the microprocessor 2 are multiplexed with the data and are divided into three busses, AD(7..0), AD(15..8), and AD(19..16). The lower 16 bits of the address/data lines are divided into the low byte (AD(7..0)) bus 11 and the high byte (AD(15..8)) bus 13.

Connected to the high and low byte address/data busses 13, 11, respectively, are associated bidirectional buffer units 16 and 18 which buffer the data in and out of the RAM memory array 14. The RAM memory 14 is divided into a lower bank 0 and an upper bank 1 as well as divided into

high and low byte sections. The arrangement of the RAM memory 14 is in accordance with standard techniques which are widely known to those skilled in the art. In other words, the 16-bit words of the RAM memory 14 are outputted
5 as high and low bytes with 8 bits per byte through the buffers 16 and 18 onto the high and low byte address/data busses of the microprocessor 2.

The four upper address/data lines from the micro-processor 2 comprise a third bus which is associated only
10 with the address of the RAM memory 14. Address latches 22, 24, and 26 respond to the three busses from the microprocessor 2 to latch in a memory address from the microprocessor. The output from the address latches 22, 24, and 26
15 comprise the address bus 58 which also forms a part of the 8-bit expansion bus 64. The address bus 58 is applied to the address MUX and memory control circuit 20 associated with the RAM memory 14 for providing the address to the RAM. The address MUX and memory control logic 20 also
20 responds to DMA operations to the RAM memory 14 under control of the DMA control 38.

The DMA control 38 may specify an address to the RAM memory 14 via the DMA page register 36, DMA address
25 latch 40, and DMA address buffer 50. The data to be stored in the RAM memory 14 under control of the DMA control 38 is provided to the buffers 16, 18 via the I/O data buffer 52 which couples the 8-bit data bus 54 (IOD (7..0)) from the DMA control 38 to the internal data bus 56 (SYSD (7..0)).
30 The internal data bus 56 is connected to each of the data-in high latches 28, the data-out high buffers 30, the data-in low latches 32, and the data-out low buffers 34. The data-in high latches 28 and data-out high buffers 30 are each connected on the output side to the microprocessor
35 2 high byte address/data bus 13. The data-in low latches 32 couple the data bus 56 to the microprocessor 2 low byte

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address/data bus 11 which in turn couples to the buffers 18 to the RAM memory 14.

The data bus 54 is an 8-bit input/output bus which
5 couples the input/output devices to the microprocessor 2.
In accordance with the present invention, the system read
only memory (ROM) 60 is coupled to this 8-bit I/O data bus
54. The address and data to the system ROM 60 is multi-
plexed onto the I/O data bus 54 via the I/O data buffer 52
10 and the data-out high buffers 30 and data-out low buffers
34 which are respectively connected to the microprocessor
high address/data bus 13 and low address/data bus 11. The
system ROM is connected to the 8-bit data bus 54 by design
choice. It could have been connected to the 16-bit bus
15 (13, 11), but would have required two ROM chips, one for
the high byte and one for the low byte.

Connected to the 8-bit I/O data bus 54 are standard
I/O logic devices, such as the interrupt control 46 and the
20 I/O controller 48, which for the presently preferred embodiment
respectively comprises an Intel 8259 interrupt
controller and an 8255 I/O controller. The operations of
these devices are in accordance with standard procedures
noted by Intel and which are well-known to those skilled in
25 the art. Accordingly, a more detailed description of their
operation will not be provided herein.

Still referring to FIG. 1, the local system bus 56
together with the address bus 58 and a plurality of control
30 lines 57 together comprise the 8-bit expansion bus 64 which
is used to expand the architecture of the present invention
to add additional hardware peripheral devices. The control
bus 57 comprises a plurality of control lines (in the case
of the present invention, 4 bits of control) that originate
35 with the bus controller 70.

In accordance with the present invention, there is provided a personal computer that is both hardware compatible with existing peripheral devices designed for certain classes of personal computers and is software compatible with a majority of application programs which have been written for that class of computers. That is, the 8-bit expansion bus 64 is designed to run at all times at a throughput rate which is equal to the rate for which the hardware was designed. An increase in the execution speed of the microprocessor 2 above the speed with which the prior art personal computers have been designed does not affect the data transfer rate over the 8-bit expansion bus 64 from the rate for which the hardware was designed. In accordance with the presently preferred embodiment, the clocking rate for the 8-bit expansion bus 64 is 4.77 MHz in both the high and low speed mode of execution for the microprocessor 2.

Still referring to FIG. 1, as mentioned, microprocessor 10 is an Intel 8086 microprocessor. This particular microprocessor chip has a significantly higher execution speed than its sister microprocessor, the Intel 8088. The Intel 8088 microprocessor chip is a very popular chip which has found widespread use by several manufacturers of personal computers. A great deal of application software was written for these personal computers using the instruction set available in the 8088 microprocessor. This instruction set is also available in the Intel 8086 microprocessor 10. This software compatibility enables the instructions in a program written for the 8088 to execute on the 8086. However, it is not possible simply by providing an Intel 8086 microprocessor in a personal computer to successfully run all application programs written for the Intel 8088. This problem results from the fact that some application software is time-dependent in that the programmers have taken advantage of the execution

speed of the 8088 in creating certain time intervals required by the routines to perform certain functions. This type of situation is very common in video game software. Without modifying this application software, going
5 to a higher execution speed microprocessor in effect changes these time intervals and renders these programs inoperative.

In accordance with the present invention, the
10 architecture shown in FIG. 1 provides for a dual mode of operation for the microprocessor 2 to take advantage of the high speed execution cycle time for the Intel 8086 where application programs can run at these higher speeds, and to have a slow mode to handle the application programs which
15 rely upon the execution cycle time for the microprocessor for which the program was written.

Although the high and slow speed microprocessor chips from Intel are software compatible, i.e., they both
20 execute the same instruction set, it is not possible to simply provide the high speed microprocessor 10 and run it at a slower clock frequency normally provided to the slow speed microprocessor and have the high speed microprocessor execute the application program at the same speed as occurs
25 when the program is executed on the slow speed microprocessor. The reason is that the internal architecture of the microprocessors are different.

In the high speed microprocessor, Intel has
30 provided a 6-byte buffer pre-fetch queue memory while in the low speed microprocessor Intel has provided a 4-byte pre-fetch buffer memory. For application programs which provide for programs jumps, and almost all application programs do, this additional amount of pre-fetch buffer
35 memory provided in the high speed microprocessor would appear to represent an additional overhead time required by

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the 8086 microprocessor to pre-fetch the data that is supposed to be in the pre-fetch buffer memory. In fact, it does not because the 8086 microprocessor is doing 16-bit word fetches from RAM memory 14 (two 8-bit bytes per word).
5 It only takes the 8086 three fetch cycles to obtain the six bytes of pre-fetch data while the 8088 running at the same clocking frequency and obtaining one 8-bit byte per fetch require four fetch cycles to obtain four bytes of pre-fetch data.

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Thus, simply reducing the clocking frequency to the microprocessor 2 from the high speed clock to the normal clocking frequency for the slow speed microprocessor results in the high speed microprocessor executing applica-
15 tion programs faster than would occur for the slow speed microprocessor running at the same clocking frequency.

On the other hand, controlling the microprocessor 2 to operate in an 8-bit access mode all the time, the amount
20 of time required to obtain the 6 bytes of pre-fetch data would require 6 fetch cycles while the slow speed microprocessor would only require 4 cycles. In this mode, the high speed microprocessor 10 would execute the application program slower than the slow speed microprocessor would for
25 the same clocking frequency.

In accordance with the present invention, to achieve for the high speed microprocessor running in the slow speed mode as near as possible the same execution time
30 for the application programs as in the slow speed microprocessor, the present invention has developed an algorithm by which every other access to the RAM memory 14 by the high speed microprocessor 2 is a word fetch. In between word fetches are 8-bit byte mode accesses. In this manner, on
35 the average, the number of accesses to the RAM memory 14

will be approximately equal to the 4 cycles required in the 8088.

This average result depends upon what access was occurring when the last program jump occurred, whether it was a word access or an 8-bit byte access. In other words, some of the time, the pre-fetch operations following a jump will begin with a word fetch cycle in which two bytes of pre-fetch data are obtained followed by a word cycle fetch that is ignored by the microprocessor 2 (the microprocessor is put into a WAIT state) followed by the same request which is not ignored by the microprocessor 2 (the microprocessor is released from the WAIT state) to obtain the next two bytes of pre-fetch, then followed by an additional word cycle request to obtain the final two bytes. For this situation, a total of four fetch cycles occurred in order to obtain the six bytes of pre-fetch data. For the other situation, the six bytes of pre-fetch would be obtained by a word access that is ignored by the microprocessor 2, followed by word access to the same location which is used to obtain the first two bytes. Following this would be a word access which would obtain the next two bytes, followed by a word access that is ignored, followed by a word access to the same address to obtain the final two bytes of pre-fetch data. For this situation a total of five fetch cycles would be used. Accordingly, on the average, the amount of time required to obtain the pre-fetch data required by the high speed microprocessor 2 when running at the slow speed is approximately equal to that which is required by the slow speed microprocessor. So, for the most part, the program execution time for the high speed microprocessor to execute a given application program, when running at the normal clocking frequency for the slow speed microprocessor, is acceptably the same.

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In order for the present invention to achieve the pre-fetch data required by the high speed microprocessor when running at the slow speed, it is necessary that in every other word access cycle from the microprocessor 2
5 that the microprocessor 10 be put into a WAIT state so that the 16 bits of data which are read from the RAM memory 14 are ignored while the data access to the same memory location 14 in the following fetch cycle produces the same 16 bits of information actually strobed into the micropro-
10 cessor 10. In this way, it takes two fetch cycles to produce the two bytes of pre-fetch data contained in a single RAM memory 14 word. The request/grant wait logic 68 responds to the clock circuit 66 to produce the necessary control signals to the microprocessor 2 to produce these
15 wait states. The bus controller 70 also responds to the clocking generator 66 and the request/grant wait logic 68 to control the buffer control 72 that in turn controls the various address latches, data buffers and latches, etc. to control the flow of data throughout the architecture of the
20 present invention.

FIGS. 2, 3, and 4, when FIG. 3 is placed to the right of FIG. 2 and FIG. 4 is placed below FIG. 2, illustrate a detail circuit diagram of the interconnection
25 between the microprocessor 2 and the DMA control 38. The plurality of address latches 22, 24 and 26 which interface the addresses from the multiplexed address/data lines from the microprocessor 2 to the address bus 58 are shown in FIGS. 2 and 4. The data-in latches 28, 32, the data-out
30 buffers 30, 34, and the RAM data buffers 16, 18 are shown in FIG. 4. Also shown in FIG. 4 is the I/O data buffer 52 which interfaces the data bus 56 to the data bus 54 as shown in FIG. 1.

35 Also shown in FIG. 3 is the logic circuit of the clock generator 66. The clock generator 66 produces

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several system clocks from a single 14.31818 MHz crystal oscillator device 76. The generated system clocks are the microprocessor 2 clock CLK, the DMA control 38 clock DCLK, clocks that synchronize the system bus related circuitry
5 BCLK and BCLK*, a clock equivalent to an inverted micro-processor 2 clock PCLK*, and a clock for timing I/O devices IOCLK.

To simplify the system design, several of the
10 system clocks are derived to be synchronous within a very few nanoseconds of each other. This is accomplished by using flip-flops within a single IC to generate the synchronous clocks. By using high speed logic, timing
15 reference points for other system timing.

Referring now just to FIG. 3, the master system clock MCLK from the crystal oscillator has a frequency of 14.31818 MHz and a period of 69.84 nanoseconds. The
20 oscillator produces an approximately 50% duty cycle clocking signal and most of the clocks described as follows are developed from the master clock MCLK's rising edge.

The system clock BCLK is the division of MCLK by
25 three with a 33% duty cycle in the logic high state. The period for this clock is 209.5 nanoseconds. The system clock BCLK* is the inverse of BCLK.

The system clock ACLK is similar to BCLK, but is
30 phase shifted one MCLK cycle later than BCLK. ACLK and BCLK are developed by two flip-flops 3, 4 which are connected as a 2-bit shift register. The input to the register is given by the following logic equation $(ACLK + BCLK)^*$.

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The system clock CCLK is the clock signal BCLK delayed by one MCLK cycle time period. It is used to operate the state machines (CPU PAL 68 and BUS PAL 70, see FIG. 8) to produce the bus commands and the buffer control
5 commands.

The system clock SWCLK (see FIG. 7) is used to time the switch of the processor clock from fast to slow mode so that the processor clock does not violate the requirements
10 of the microprocessor 2. It is the OR function of BCLK* and PCLK* so that it goes low for one MCLK cycle time every other time BCLK* goes low during the FAST mode. During the SLOW mode, it is equal to the clocking signal BCLK*.

The system clock DCLK is synchronous on the falling edge with the falling edge of BCLK, but is adjusted on the rising edge to be more nearly a 50% duty cycle clock. This is accomplished by presetting flip-flop 78 to a logic high state on the falling edge of MCLK halfway through the DCLK
15 cycle.
20

The system clock PCLK* runs at one of two frequencies depending upon the mode of the processor system. In the FAST mode, PCLK* is a divide by two of the
25 MCLK with a frequency of 7.16 MHz and a period of 139.68 nanoseconds. In the SLOW mode, PCLK* is the same as BCLK*. This is accomplished by using a multiplexer 80 to switch the input of the PCLK* flip-flop 82 from ACLK* to PCLK.

The system clock CLK is the processor clock, and has the same two frequencies as PCLK*. It's falling edge is nearly synchronous with the rising edge of PCLK* except for propagation delays through certain logic circuits. In the SLOW mode, PCLK* goes through two parts of multiplexer
30 84 and is buffered by a clock driver to form the signal
35 CLK. The CLK signal will have the inherent 33% duty cycle

of the divide by three counter, except for the different high/low delays of the MUX and driver flip-flop. In the fast mode, the multiplexer 86 which drives the clock driver selects a version of the PLCK* which is delayed by a delay line for 20 nanoseconds. This is to adjust the CLK output to be more nearly 33% duty cycle at this higher frequency.

The clock driver is AC coupled to the multiplexer 84 so that each of the driver transistors Q3, Q4 will be turned on for only a portion of the cycle time, about 25 nanoseconds. This is required to prevent both transistors from being turned on at once by storage time problems or the differential delay in the paths driving each transistor. The capacity of load on the CLK line (100pf max) will keep the CLK signal from decaying in the 115 nanosecond (max) time when the transistors are not turned on.

The IOCLK is a divide by two of the BCLK* clock. The frequency of IOCLK is 2.3863633 MHz yielding a period of 419 nanoseconds. The IOCLK clock does not require a fixed phase relationship with the other system clocks as it is used only for counting time.

For the system clocks mentioned above (CLK, PCLK*) which are switched in frequency, the switching occurs during any DMA cycle. This is to prevent the bus control state machines from becoming confused by a mode switch during their active times. In addition, the mode switch from FAST to SLOW mode occurs when the phase relationship of BCLK and PCLK are such that PCLK has just gone low and will remain low for two and only two MCLK cycles after the mode switch. This is accomplished by gating PAEN with the signal SWCLK to synchronize the TURBO control line and form the signal SLOW (the mode select signal). This will allow a smooth transition of the bus state machines and provide a

clean clock transition. (See FIG. 7 for the generation of the signal SLOW.)

Turning now to FIGS. 7 and 8 when FIG. 8 is placed to the right of FIG. 7, there is formed a detail circuit diagram of the request/grant wait logic 68, the bus controller 70, and the buffer control logic 72 shown in FIG. 1. The function of the request/grant wait logic 68, the bus controller 70, and the buffer controller 72 is to replace the normal controller functions of Intel's 8288 bus controller and 8284 ready logic which are normally associated with the use of Intel's 8086 microprocessor and 8087 coprocessor.

Referring to FIG. 8, there is shown the CPUPAL 68 which is a 6 registered, 2 normal outputs PAL device. It is clocked by the PCLK* clock. The design equations for the programming of CPUPAL 68, as well as all of the other PALs discussed below, is given in the PAL design equation appendix.

Still referring to FIG. 8, the rising edge of PCLK* is nearly synchronous with the falling edge of the microprocessor 2 clock CLK. The logic in the CPUPAL 68 implements the hold request/hold acknowledge to RQ/GT conversion (PAEN*, RQ*, and WGT*), some of the processor ready logic (PRDY), and the logic which starts request on the 16-bit memory (M16*, M16C*, and M16RD*).

Also shown in FIG. 8 is the BUSPAL 70 which is an 8 registered tri-state output pal device. The BUSPAL 70 is clocked by the CCLK clock. The rising edge of this clock is the same as the falling edge of the microprocessor 2 clock in the SLOW mode. The logic in the BUSPAL 70 generates the 5 bus commands (MRDC, MWTC, IORC, IOWC, and INTA), signals which indicate the end of a command (CMDEND and

CMX), and the high byte of each word access to the 8-bit bus 54. The outputs of the BUSPAL 70 are only enabled when the microprocessor 2 is active. During DMA operations, the command outputs (MRDC, MWTC, IORC, and IOWC) are driven by the DMA control 38 shown in FIG. 2, the AOX* output is pulled to an inactive high, and the CMX* output is driven by the RAM SWMUX signal.

Both the CPUPAL 68 and the BUSPAL 70 contain logic which senses the ready state of the system bus and adjusts the system timing accordingly.

Also shown in FIG. 8 is the BUFPAL 72 which is a 14 input, 8 output pal device and is not clocked by any of the system clocks. The BUFPAL 72 contains logic to control the various buffers and latches which implement the 16 to 8-bit bus conversion between the microprocessor 2 address/data busses (13, 11), and the address bus 58 and data bus 56. The signals which control this conversion are B8IN*, B8HOUT*, B8LOUT*, B8HLAT, and B8LLAT. The BUFPAL 72 also contains logic to control the I/O data buffers (IODEN* and IODIR), and logic to control the generation of the standard system wait states on I/O and DMA operations (WAITCLK).

Turning now to FIGS. 5 and 6, when FIG. 6 is placed to the right of FIG. 5 forms a detail circuit diagram of the RAM memory 14 and address MUX and memory control 20 as shown in FIG. 1. The RAM memory system 14 consists of two banks of 18 DRAM ICs. Each of the two banks is further split into a high and low sets of nine ICs each which correspond to the high and low bytes of a microprocessor 2 word. Parity checking is done on each set individually to allow single byte or word accesses to the RAM memory 14. The RAM memory 14 timing is developed asynchronously with a delay line to allow RAM access at each of the two microprocessor 2 clock speeds and from the DMA control 38.

FIG. 5 is an illustration of the address multiplexer and memory control logic 20 as shown in FIG. 1. The address MUX and memory control 20 comprises a control pal MEMPAL 90, a delay line 92, a pair of address multiplexers 94, 96, whose output signal lines contain series damping resistors as do the control lines from the MEMPAL 90. The output from the multiplexers 94, 96 and the MEMPAL 90 are applied directly to the array of DRAM chips as shown in FIG. 6.

10

The RAM memory 14 read cycle begins when the CPU PAL 68 recognizes the status of a memory read and sets the M16* and M16RD* signals active. The M16* signal directly drives the TTL delay line 92 and the MEMPAL 90 to begin the access cycle. The MEMPAL 90 decodes the address produced by the microprocessor 2 and enables the appropriate RASx* output to strobe in the row address to the DRAM in RAM array 14. When the M16* signal has propagated through the delay line 92 to generate the signal SWMUX output, the SWMUX signal changes the address to the DRAM array 14 from row to column. After another 15 nanosecond delay in the delay line, the RCAS* line becomes active. Since the M16RD* signal is active, the MEMPAL 90 decodes the bus status to determine which CASx* to enable as RCAS* becomes true. The DRAM array 14 then completes the access and sends the data to the microprocessor 2. At the end of the cycle, the parity status is clocked and latched if there was a parity error on read.

30

The data buffers 16, 18 are enabled by the RCAS* line 75 nanoseconds after the M16* line goes active. This allows time for the microprocessor 2 to disable its multiplexed address buffers to prevent a bus clash. The direction line to the data buffer (MDIR) comes on before the RCAS* line and is held on after all RCAS* goes away to insure that the direction is always correct. The MDIR line

35

is also used to clock in the parity status because it is only present on the read cycle and it goes high at the very end of the read cycle allowing enough time to calculate the parity after data is available.

5

The RAM memory array 14 is refreshed by the DMA controller 38 about every 15 microseconds. The refresh cycle is different than other DMA memory read cycles in that it is shorter (2 DCLK cycles) and in that the RAM is not actually read. Also, the MEMPAL 90 causes both banks of RAM chips to be cycled at once so it is not necessary to specifically address each bank when refreshing. The MEMPAL 90 prevents any CAS* strobes from occurring during refresh, preventing any actual reading or writing of the RAMs.

Turning now to FIGS. 9 and 10, there are shown the timing diagrams for the basic command cycles which occur in the FAST mode (FIG. 9) and in the SLOW mode (FIG. 10). The following Table I provides a listing of the basic cycle types which can occur in the present invention.

TABLE I

PROCESSOR CYCLE TYPES

25

30	FAST CPU MEM READ	16 RAM	LOW BYTE
	FAST CPU MEM READ	16 RAM	HIGH BYTE
	FAST CPU MEM READ	16 RAM	WORD
	FAST CPU MEM READ	8 BUS	LOW BYTE
	FAST CPU MEM READ	8 BUS	HIGH BYTE
35	FAST CPU MEM READ	8 BUS	WORD LOW BYTE
	FAST CPU MEM READ	8 BUS	WORD HIGH BYTE
	FAST CPU MEM WRITE	16 RAM	LOW BYTE
	FAST CPU MEM WRITE	16 RAM	HIGH BYTE
	FAST CPU MEM WRITE	16 RAM	WORD
40	FAST CPU MEM WRITE	8 BUS	LOW BYTE
	FAST CPU MEM WRITE	8 BUS	HIGH BYTE
	FAST CPU MEM WRITE	8 BUS	WORD LOW BYTE
	FAST CPU MEM WRITE	8 BUS	WORD HIGH BYTE
	FAST CPU I/O READ	8 BUS	LOW BYTE
	FAST CPU I/O READ	8 BUS	HIGH BYTE

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	FAST CPU I/O READ	8 BUS	WORD LOW BYTE
	FAST CPU I/O READ	8 BUS	WORD HIGH BYTE
	FAST CPU I/O WRITE	8 BUS	LOW BYTE
	FAST CPU I/O WRITE	8 BUS	HIGH BYTE
5	FAST CPU I/O WRITE	8 BUS	WORD LOW BYTE
	FAST CPU I/O WRITE	8 BUS	WORD HIGH BYTE
	FAST CPU INTA READ	8 BUS	LOW BYTE
	FAST CPU INTA READ	8 BUS	HIGH BYTE
	FAST CPU HALT		
10	SLOW CPU MEM READ	16 RAM	LOW BYTE
	SLOW CPU MEM READ	16 RAM	HIGH BYTE
	SLOW CPU MEM READ	16 RAM	WORD
	SLOW CPU MEM READ	8 BUS	LOW BYTE
	SLOW CPU MEM READ	8 BUS	HIGH BYTE
15	SLOW CPU MEM READ	8 BUS	WORD LOW BYTE
	SLOW CPU MEM READ	8 BUS	WORD HIGH BYTE
	SLOW CPU MEM WRITE	16 RAM	LOW BYTE
	SLOW CPU MEM WRITE	16 RAM	HIGH BYTE
	SLOW CPU MEM WRITE	16 RAM	WORD
20	SLOW CPU MEM WRITE	8 BUS	LOW BYTE
	SLOW CPU MEM WRITE	8 BUS	HIGH BYTE
	SLOW CPU MEM WRITE	8 BUS	WORD LOW BYTE
	SLOW CPU MEM WRITE	8 BUS	WORD HIGH BYTE
	SLOW CPU I/O READ	8 BUS	LOW BYTE
25	SLOW CPU I/O READ	8 BUS	HIGH BYTE
	SLOW CPU I/O READ	8 BUS	WORD LOW BYTE
	SLOW CPU I/O READ	8 BUS	WORD HIGH BYTE
	SLOW CPU I/O WRITE	8 BUS	LOW BYTE
	SLOW CPU I/O WRITE	8 BUS	HIGH BYTE
30	SLOW CPU I/O WRITE	8 BUS	WORD LOW BYTE
	SLOW CPU I/O WRITE	8 BUS	WORD HIGH BYTE
	SLOW CPU INTA READ	8 BUS	LOW BYTE
	SLOW CPU INTA READ	8 BUS	HIGH BYTE
	SLOW CPU HALT		
35	DMA MEM READ	16 RAM	LOW BYTE
	DMA MEM READ	16 RAM	HIGH BYTE
	DMA MEM READ	8 BUS	LOW BYTE
	DMA MEM READ	8 BUS	HIGH BYTE
	DMA MEM WRITE	16 RAM	LOW BYTE
40	DMA MEM WRITE	16 RAM	HIGH BYTE
	DMA MEM WRITE	8 BUS	LOW BYTE
	DMA MEM WRITE	8 BUS	HIGH BYTE

45 In the following discussion, references to "16 BUS" or "16 RAM" refer to the 16-bit bus comprised of the micro-processor 2 address/data line AD15..0 (busses 13 and 11 as shown in FIG. 1). References to "8 BUS" refer to the 8-bit I/O bus 54 also shown in FIG. 1.

50

Referring now to FIG. 9, there is shown the timing diagram for the microprocessor 2 cycle types for the FAST mode of operation. Basically, there are two types of bus accesses in the FAST mode. The first is an access to the 16-bit RAM memory 14, and the other is to everything else which involves 8-bit accesses. When accessing the 16-bit RAM memory 14, the controller state machines let the microprocessor 2 run at full speed. The 16-bit memory cycle begins when the status indicates a memory operation. As soon as the signal SX goes active, the CPUPAL 68 sets the M16* signal active signalling the beginning of the RAM memory 14 cycle. If the operation is a read, the signal M16RD* also goes active. On the rising edge of the PCLK*, the signal M16C* goes active. The M16C* signal is used internally to the CPUPAL 68 to hold M16* and M16RD* active until the end of the command. On this 16-bit access cycle, the PRDY line stays high so that the microprocessor 2 will not generate any wait states. If the microprocessor 2 status indicates that only one byte (high or low) of the 16-bit memory 14 is to be accessed, then the MEMPAL 90 will decode this and activate only the CAS* line for this specific half of the RAM memory array 14.

For non 16-bit RAM memory 14 accesses, due to the early start of the memory cycle, there are some particular effects that need to be discussed. All memory cycles begin when the status indicates a memory operation. As soon as SX goes active, the CPUPAL 62 sets the M16* line active signaling the beginning of the RAM cycle. This occurs regardless of the address because the address is not guaranteed to be present early in the cycle. For non 16-bit memory accesses, the M16C* line will not go active on the rising edge of PCLK* and PRDY will go inactive. This is because M16C* and PRDY are fully qualified with the address through the MEM16* signal from the MEMPAL 90 (indicating a 16-bit memory access). In this case, the

PRDY line going inactive will disable M16* after the rising edge of PCLK*. The resulting short edge on M16* (15 nano-seconds) will be ignored by the MEMPAL 90, and the 16-bit memory subsystem because of further address qualification
5 within the MEMPAL 90.

Still referring to Figure 9, when accessing the 8-bit bus 54 for a single byte, the CPUPAL 68 sets the PRDY line low immediately on the rising edge of PCLK* during
10 interval T2. On the rising edge of CCLK, the BUSPAL 70 will generate the command that is indicated by the status (B2). Note that there may be from one to three MCLK cycles before the command starts due to the synchronization requirement between the two state machines. The BUSPAL 70
15 sets CMX* low on the next falling edge of all CCLK if the WAIT line is inactive (B3). If the WAIT line is active, the BUSPAL 70 will enter the BUS WAIT state (BW) until WAIT goes inactive. During this time, the CPUPAL 68 has the microprocessor 2 in a WAIT state (TW). On the rising edge
20 of CCLK at (B4), the command is made inactive.

Because the cycle is a single byte access, the BUSPAL 70 sets the CMDEND* line active during B2. When the CPUPAL 68 recognizes that both CMDEND* and CMX* are active,
25 it will allow the PRDY line to go active on the next rising edge of PCLK* at T3. This is subject to one or two MCLK cycles of synchronization delay. The microprocessors 2 status will then go inactive to end the access at T4. The signal CMX* will stay active during the bus interval B4 and
30 will be used to hold some of the data buffers active to provide a data hold time for system write.

If the 8-bit bus cycle being executed involves word operation, then two cycles are run on the 8-bit bus 54.
35 The low byte is accessed first, followed by the high byte. Initially, the CPUPAL 68 sets the PRDY signal low immedi-

ately on the rising edge of PCLK* doing T2. On the next rising edge of CCLK, the BUSPAL 70 will generate the command that is indicated by the status at B2L time. Note that there may be from one to three MCLK cycles before the
5 command starts due to the synchronization requirements of the two state machines. During the remainder of the cycle, the CPUPAL 68 has the microprocessor 2 in a WAIT state TW.

The BUSPAL 70 sets CMX* low on the next falling
10 edge of CCLK if the WAIT line is inactive at B3L time. If the WAIT signal is active, the BUSPAL 70 will enter the bus WAIT state BWL until WAIT goes inactive. On the rising edge of CCLK at B4L time, the command is made inactive.

15 At the beginning of the next clock at B1H time, the signal AOX is set low and the CMX* signal is set high. The signal AOX is used to force the address lines AOB sent to the system address bus to a logic high even though the microprocessor 2 AO address line is low. This changes the
20 address for the second half of the word access. At the next CCLK clock, a second command and the CMDEND* line is made active (B2H).

At this time, the BUSPAL 70 sets CMX* low on the
25 next falling edge of CCLK if the WAIT signal is inactive (B3H). If the WAIT line is active, the BUSPAL 70 will enter the bus WAIT state (BWH) until WAIT goes inactive. On the rising edge of CCLK at B4H time, the command is made inactive.

30

When the CPUPAL 68 recognizes that both CMDEND* and CMX* are active (B3H), it will allow the PRDY line to go active on the next rising edge of PCLK* at T3 time. This is subject to one or two MCLK cycles of synchronization
35 delay. The microprocessor 2 status will then go inactive to end the access (T4). The signal CMX* will stay active

Turning now to Figure 10, there is shown the timing diagram for the basic microprocessor 2 command cycles for the SLOW mode of operation. In the SLOW mode, the clocks driving the CPUPAL 68 and the BUSPAL 70 are the same, so they may be treated as one large state machine. In addition, both clocks are at the system bus speed (4.77 MHz) so there is no requirement to slow the microprocessor 2 down to make accesses on the 8-bit bus 54. In accordance with the present invention, to more closely simulate the execution speed of the slow microprocessor by the fast microprocessor 2, the state machines treat some of the word accesses to the 16-bit memory 14 as byte accesses. In other words, two identical cycles are run for word accesses instead of actually operating on one-half and then the other.

20 It has been determined that to most closely simulate the running of an application program on the slow microprocessor out of the 16-bit RAM memory 14, some of the fetches need to be word operations in order to increase the
25 average speed of the processor 2. This is because the microprocessor 2 internal queue is longer than the internal queue of the slower microprocessor. The fast microprocessor tends to spend more time fetching instructions to fill its internal pre-fetch queue. To achieve this
30 average, word instruction fetches which fall on an address boundary such that address line A1 is a logic high, are processed as word operations in the 16-bit memory 14. All other fetches, reads and writes are done as byte operations in accordance with the above procedure, i.e., two consecutive
35 16-bit RAM 14 accesses with the first access ignored.

Still referring to Figure 10, when accessing the 8-bit bus 54 for a single byte, the CPUPAL 68 sets the PRDY line low immediately on the rising edge of PCLK* during T2. At the same time, the BUSPAL 70 will generate the command that is indicated by the status (B2). The BUSPAL 70 sets CMX* low on the next falling edge of CCLK if the WAIT line is inactive (B3). If the WAIT line is active the BUSPAL 70 and CPUPAL 68 will enter a wait state (TW,BW) until WAIT goes inactive. On the rising edge of CCLK at (T4,B4) the command is made inactive.

Because the cycle is a single byte access, the BUSPAL 70 sets the CMDEND* line active during (T2,B2). When the CPUPAL 68 recognizes the CMDEND* is active and WAIT is inactive, it will allow the PRDY line to go active at the beginning of (T3,B3). The CPU status will then go inactive to end the access (T4). CMX* will stay active during (T4,B4) and is used to hold some of the data buffers active to provide a data hold time for system writes.

If the 8-bit bus cycle being executed involves a word operation, two cycles are run on the 8-bit bus 54. Initially, the CPUPAL 68 sets the PRDY line low immediately on the rising edge of PCLK* during T2. At the same time the BUSPAL 70 will generate the command that is indicated by the status (B2L). During the remainder of the word cycle the CPUPAL 68 has the microprocessor 2 in a wait state (TW).

The BUSPAL 70 sets CMX* low on the next falling edge of CCLK if the WAIT line is inactive (B3L). If the WAIT line is active the BUSPAL 70 will enter the BUS wait state (BWL) until wait goes inactive. On the rising edge of CCLK at (B4L) the command is made inactive.

At the beginning of the next clock (B1H) the AOX line is set low and the CMX* line is set high. The AOX line is used to force the address line AOB sent to the system address bus to a high even though the CPU AO line is low. This changes the address for the second half of the word access. At the next CCLK a second command and the CMDEND* line is made active (B2H). The BUSPAL 70 sets CMX* low on the next falling edge of CCLK if the WAIT line is inactive (B3H). If the WAIT line is active the BUSPAL 70 will enter the BUS wait state (BWH) until wait goes inactive. On the rising edge of CCLK at (B4H) the command is made inactive.

When the CPUPAL 68 recognizes that CMDEND* is active and WAIT is inactive (B3H), it will allow the PRDY line to go active (T3). The microprocessor 2 status will then go inactive to end the access (T4). The second CMX* will stay active during bus B4H as in the single byte access case. At the end of B4H, both CMX* and AOX will go inactive (high) thus ending the word access.

When accessing the 16-bit memory 14 in the SLOW mode, the controller state machines (CPUPAL 68 and BUSPAL 70) do not attempt to start the memory cycle early. Instead the M16C* line is set active on the rising edge of CCLK following SX becoming active. This results in M16* going active and, if the status indicates a read operation, M16RD* goes active. Both of these signals are fully qualified by the MEM16* signal from the MEMPAL 90 which indicates a valid 16 bit address. In other respects, the 16 bit memory cycles are the same as those for the 8-bit described above.

Referring once again to FIG. 8, the data buffers which direct the data between the 16-bit bus (buses 11 and 13) and the 8 bit system bus 54 are controlled by the

BUFPAL 72 shown in FIG. 8. The following TABLE 2 shows which buffers and latches are enabled from the output signals from BUFPAL 72 during what commands.

TABLE 2

PROCESSOR CYCLE TYPES

			B8IN*	B8LOUT*	B8HOUT*	B8LLAT	B8HLAT
5	CPU NO COMMAND		H	H	H	L	L
	CPU MEM READ	16 RAM	H	H	H	L	L
	CPU MEM READ	8 BUS LOW BYTE	L	H	H	H	L
	CPU MEM READ	8 BUS HIGH BYTE	L	H	H	L	H
10	CPU MEM WRITE	16 RAM	H	H	H	L	L
	CPU MEM WRITE	8 BUS LOW BYTE	H	L	H	L	L
	CPU MEM WRITE	8 BUS HIGH BYTE	H	H	L	L	L
	CPU I/O READ	8 BUS LOW BYTE	L	H	H	H	L
	CPU I/O READ	8 BUS HIGH BYTE	L	H	H	L	H
15	CPU I/O WRITE	8 BUS LOW BYTE	H	L	H	L	L
	CPU I/O WRITE	8 BUS HIGH BYTE	H	H	L	L	L
	CPU INTA READ	8 BUS LOW BYTE	L	H	H	H	H
	CPU INTA READ	8 BUS HIGH BYTE	L	H	H	H	H
	CPU HALT		H	H	H	L	L
20	DMA NO COMMAND		H	H	H	H	H
	DMA MEM READ	16 RAM LOW BYTE	H	L	H	H	H
	DMA MEM READ	16 RAM HIGH BYTE	H	H	L	H	H
	DMA MEM READ	8 BUS	H	H	H	H	H
	DMA MEM WRITE	16 RAM LOW BYTE	L	H	H	H	H
25	DMA MEM WRITE	16 RAM HIGH BYTE	L	H	H	H	H
	DMA MEM WRITE	8 BUS	H	H	H	H	H

When the B8IN* signal goes active during a microprocessor 2 read cycle, it is held on slightly after the read command goes away until the RDEN* goes inactive.

5 This is to guarantee that the data will be presented to the microprocessor with the required setup and hold time particularly in the FAST mode when the read command can go away before the microprocessor 2 samples the data (due to state machine synchronization).

10

When a B8xOUT* line goes active during a write cycle, it is held on after the write command goes away until the CMX* line goes inactive. This keeps the data present on the bus to help satisfy the required write hold
15 times of most peripherals. During microprocessor 2 writes, this is a complete BCLK* cycle. During DMA reads, this is 75 nsec after the read command goes away (controlled by the RAM delay line).

20

The B8xLAT* signals are used for two purposes. The first is to hold the result of a low byte bus read when a full word is being read. The second purpose is to latch and hold read data at the end of a read command until the microprocessor 2 is ready for it. This could
25 be either zero to one MCLK cycle times depending on the synchronization of BCLK* and PCLK*.

In order to properly latch the data from the system bus, the data must be present for a certain hold
30 time from the read commands on the bus. In order to minimize this hold time, the BUFPAL 72 uses CCLK going low to gate the latch signals. Since CCLK's rising edge causes the read commands (MRDC* and IORC*) to end, this provides the earliest possible time to latch the latches.

35

In describing the invention, reference has been made to a preferred embodiment. However, those skilled in the art and familiar with the disclosure of the invention may recognize additions, deletions, substitutions, or
5 other modifications which would fall within the purview of the invention as defined in the appended claims.

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APPENDIX FOR PAL DESIGN DATA

PAL20L8
MEMPAL
MEMORY CONTROL PAL

A8 A16 A19 /RCAS SWMUX A18 A17 A0 /BME /M16 /M16RD GND
/DACK0 MS1 /MEM16 MDIR /WCAS /CASB /CASL /RAS1 /RAS0 RAMA6 MS0 VCC

IF (VCC)
MEM16 = /MS1 * /A19 ;640K, 512K (BANK 1) 256K*2
+ /MS1 * /MS0 * A19 * /A18 * /A17 ;640K (BANK 0) 64K*2
+ MS1 * /A19 * /A18 * /A17 ;256K (BANK 0) 64K*2
+ MS1 * MS0 * /A19 * /A18 * A17 ;256K (BANK 1) 64K*2
+ DACK0 ;REFRESH

IF (VCC)
RAS0 = M16 * /MS0 * /MS1 * A19 * /A18 * /A17 ;640K SEL 64K BANK UPPER
+ M16 * MS1 * /A19 * /A18 * /A17 ;128K, 256K SEL 64K BANK LOWER
+ M16 * DACK0 ;REFRESH
+ /SWMUX * RAS0 ;EXTEND BY 50 NSEC

IF (VCC)
RAS1 = M16 * /MS1 * /A19 ;640K, 512K SEL 256K BANK
+ M16 * MS0 * MS1 * /A19 * /A18 * A17 ;256K SEL 64K BANK UPPER
+ M16 * DACK0 ;REFRESH
+ /SWMUX * RAS1 ;EXTEND BY 50 NSEC

IF (VCC)
CASL = /A0 * M16RD * RCAS * /DACK0 * M16 * RAS0 ;READ CAS LOW BYTE BK 0
+ /A0 * M16RD * RCAS * /DACK0 * M16 * RAS1 ;READ CAS LOW BYTE BK 1
+ /A0 * /M16RD * WCAS * /DACK0 * M16 ;WRITE CAS LOW BYTE
+ RCAS * CASL * WCAS ;EXTEND CAS BY 75 NSEC

IF (VCC)
CASH = A0 * M16RD * RCAS * /DACK0 * M16 * RAS0 ;READ CAS HIGH BYTE DMA BK 0
+ A0 * M16RD * RCAS * /DACK0 * M16 * RAS1 ;READ CAS HIGH BYTE DMA BK 1
+ BME * M16RD * RCAS * /DACK0 * M16 * RAS0 ;READ CAS HIGH BYTE CPU BK 0
+ BME * M16RD * RCAS * /DACK0 * M16 * RAS1 ;READ CAS HIGH BYTE CPU BK 1
+ A0 * /M16RD * WCAS * /DACK0 * M16 ;WRITE CAS HIGH BYTE DMA
+ BME * /M16RD * WCAS * /DACK0 * M16 ;WRITE CAS HIGH BYTE CPU
+ RCAS * CASH * WCAS ;EXTEND CAS BY 75 NSEC

IF (VCC)
/MDIR = M16RD ;CHANGE DIRECTION ON READ
+ /MDIR * RCAS ;EXTEND BY 75 NSEC FROM READ

IF (VCC)
/RAMA6 = /A8 * SWMUX * /DACK0 ;NORMAL ROW ADDRESS
+ /A16 * /SWMUX ;NORMAL COL ADDRESS
+ /A0 * SWMUX * DACK0 ;REFRESH ROW ADDRESS

IF (GND)
WCAS = GND

APPENDIX FOR PAL DESIGN DATA (cont'd)

PAL2086

CAUPAL

CPU READY, MEM INTF, AND RD/WT LOGIC

<p> CM /S2 /MRDC /MWTG /CMX /CMDEND /MEM16 SX /OE WAIT /M16RD /RDEN PRDY /PAEN /WGT /M16C /RD /M16 SLOW VCC </p>	<p> MRQ /RQGT /S1 GND /RD /M16 SLOW VCC </p>
<p> /PRDY := /SLOW * /RDEN * PRDY * /CMX * /CMDEND * SX * /S2 * /MEM16 + /SLOW * /RDEN * PRDY * /CMX * /CMDEND * SX * S2 + /SLOW * /PRDY * /CMX + /SLOW * /PRDY * /CMDEND + SLOW * SX * PRDY + SLOW * SX * /PRDY * /CMDEND + SLOW * SX * /PRDY * WAIT </p>	<p> WHEN FAST AND NO CYCLE WAIT ON NON 16 MEMORY CYCLES WHEN FAST AND NO CYCLE WAIT ON ALL OTHER CYCLES UNTIL BOTH CMX AND CMDEND SIGNAL END OF COMMAND ALWAYS SET NOT READY WHEN SLOW HOLD UNTIL CMD END and HOLD UNTIL BUS IS READY </p>
<p> RDEN := /PRDY + MRDC * MWTG </p>	<p> DELAYED VERSION OF PRDY FOR TESTING </p>
<p> M16C := SX * /S2 </p>	<p> WHEN A 16 MEM CPU CYCLE OCCURS </p>
<p> RQ := MRQ * PAEN * /WGT * /RD + /MRQ * /PAEN * WGT * /RD + MRDC * MWTG </p>	<p> REQUEST HOLD WHEN CPU ACTIVE AND MRQ SEND RELEASE WHEN MRQ GOES AWAY FOR TESTING </p>
<p> WGT := MRQ * PAEN * /WGT * RQ + MRQ * PAEN * WGT * /RD + /MRQ * /PAEN * /RD + MRDC * MWTG </p>	<p> WAIT FOR GRANT (XR -> XW) BEGINS WAITING FOR GRANT (XW) HOLD REQ ENDS (XS, XD) FOR TESTING </p>
<p> PAEN := /PAEN * WGT * RQ * /MRQ + PAEN * /WGT + PAEN * WGT * /RD * MRQ * /RQGT + MRDC * MWTG </p>	<p> CPU ENABLE BEGINS (XD -> XI) HOLDS DURING IDLE (XI) AND REQUEST (XR) AND WHILE WAITING FOR GRANT (XW, XG) FOR TESTING </p>
<p> IF (VCC) M16 := SX * /S2 * /M16C + M16C * MEM16 + MRDC * /PAEN * MEM16 + MWTG * /PAEN * MEM16 </p>	<p> WHEN THE CPU WANTS THE MEMORY. HOLD UNTIL END OF COMMAND CYCLE DMA MEMORY READ DMA MEMORY WRITE </p>
<p> IF (VCC) M16RD := MEM16 * SX * /S2 * S1 + MEM16 * MRDC * /PAEN + M16 * M16RD * /MWTG </p>	<p> READ WHEN CPU WANTS READ MEMORY DMA MEMORY READ UNTIL M16 IS FINISHED </p>

APPENDIX FOR PAL DESIGN DATA (cont'd)

PAL20A8

BUSPAL

BUS COMMAND GENERATOR

CX NC /S2 A0 /BHE /B0 /MEM16 BX PRDY /RDEN /S1 GND
/OE WAIT /A0X /IORC /IOWC /INTA /CMDEND /CMX /MWTC /MRDC SLOW VCC

MRDC := /SLOW * /CMX * /PRDY *
/S2 * S1 * /MEM16
+ SLOW * /CMX * SX *
/S2 * S1
FAST, WHEN IN WAIT STATE
AND A BUS MEM READ OR
SLOW, WHEN STATUS OK
AND ANY MEM READ

MWTC := /SLOW * /CMX * /PRDY *
/S2 * /S1 * S0 * /MEM16
+ SLOW * /CMX * SX *
/S2 * /S1 * S0
FAST, WHEN IN WAIT STATE
AND A BUS MEM WRITE OR
SLOW, WHEN STATUS OK
AND ANY MEM WRITE

IORC := /SLOW * /CMX * /PRDY *
S2 * S1 * /S0
+ SLOW * /CMX * SX *
S2 * S1 * /S0
FAST, WHEN IN WAIT STATE
AND ANY I/O READ OR
SLOW, WHEN STATUS OK
AND ANY I/O READ

IOWC := /SLOW * /CMX * /PRDY *
S2 * /S1 * S0
+ SLOW * /CMX * SX *
S2 * /S1 * S0
FAST, WHEN IN WAIT STATE
AND ANY I/O WRITE OR
SLOW, WHEN STATUS OK
AND ANY I/O WRITE

INTA := /SLOW * /CMX * /PRDY *
S2 * S1 * S0
+ SLOW * /CMX * SX *
S2 * S1 * S0
FAST, WHEN IN WAIT STATE
AND INTERRUPT ACK OR
SLOW, WHEN STATUS OK
AND INTERRUPT ACK

A0X := /A0 * BHE * CMX * /A0X * /INTA *
/IOWC * /IORC * /MWTC * /MRDC * RDEN
+ /CMX * A0X * RDEN
+ CMX * A0X * INTA * RDEN
+ CMX * A0X * IOWC * RDEN
+ CMX * A0X * IORC * RDEN
+ CMX * A0X * MRDC * RDEN
+ CMX * A0X * MWTC * RDEN
HIGH ADDRESS OF WORD START
(B1H)
TILL CMD START (B2H, B4H, B3H)
AFTER CMD END (B4H)
AFTER CMD END (B4H)
AFTER CMD END (B4H)
AFTER CMD END (B4H)
AFTER CMD END (B4H)

CMDEND := /SLOW * /PRDY * A0
+ /SLOW * /PRDY * /BHE
+ /SLOW * /PRDY * A0X * /A0 * BHE
+ SLOW * SX * A0
+ SLOW * SX * /BHE
+ SLOW * /A0 * BHE * /CMX * A0X * RDEN
SINGLE CYCLE FAST HIGH (B2-B3)
SINGLE CYCLE FAST LOW (B2-B3)
BOTH CYCLE FAST (B2H-B3H)
SINGLE CYCLE SLOW HIGH (B2-B3)
SINGLE CYCLE SLOW LOW (B2-B3)
BOTH CYCLE SLOW (B2H-B2H)

CMX := /WAIT * INTA
+ /WAIT * IORC
+ /WAIT * IOWC
+ /WAIT * MRDC
+ /WAIT * MWTC
BUS CYCLE COMMAND (B3, B4)
BUS CYCLE COMMAND (B3, B4)
BUS CYCLE COMMAND (B3, B4)
BUS CYCLE COMMAND (B3, B4)
BUS CYCLE COMMAND (B3, B4)

APPENDIX FOR PAL DESIGN DATA (cont'd)

PAL20L8

BUFPAL

BUFFER CONTROL PAL

AB A9 /MRDC /MWTC /CMX ROM /INTA /IOWC /IORC /JXCS A0B GND /PAEN /MEM16
BBHLAT /BBIN /BBLOUT /BBHOUT /IODEN B0LLAT /IODIR WAITCLK /RDEN VCC

IF (VCC)

BBIN := MRDC * RDEN * PAEN * /MEM16
+ IORC * RDEN * PAEN
+ INTA * RDEN * PAEN
+ BBIN * RDEN * PAEN
+ MWTC * /PAEN * MEM16

ICPU READ MEM 8
ICPU READ I/O
ICPU READ INTERRUPT ACK
ICPU IN HOLD TILL READY
IDMA WRITE TO MEM16

IF (VCC)

BBLOUT := MWTC * PAEN * /A0B * /MEM16
+ IOWC * PAEN * /A0B
+ MRDC * IOWC * /PAEN * /A0B * MEM16
+ CMX * BBLOUT

ICPU WRITE MEM 8
ICPU WRITE I/O
IDMA READ MEM16
IHOLD ENABLE AFTER CMD

IF (VCC)

BBHOUT := MWTC * PAEN * A0B * /MEM16
+ IOWC * PAEN * A0B
+ MRDC * IOWC * /PAEN * A0B * MEM16
+ CMX * BBHOUT

ICPU WRITE MEM 8
ICPU WRITE I/O
IDMA READ MEM16
IHOLD ENABLE AFTER CMD

IF (VCC)

/B0LLAT := /MRDC * /IORC * /INTA * PAEN
+ MRDC * /IORC * /INTA * PAEN * A0B
+ /MRDC * IORC * /INTA * PAEN * A0B

IHOLD WHEN NO READ CPU CMD
IHOLD WHEN READING HIGH BYTE
IHOLD WHEN READING HIGH BYTE

IF (VCC)

/BBHLAT := /MRDC * /IORC * /INTA * PAEN
+ MRDC * /IORC * /INTA * PAEN * /A0B
+ /MRDC * IORC * /INTA * PAEN * /A0B

IHOLD WHEN NO READ CPU CMD
IHOLD WHEN READING LOW BYTE
IHOLD WHEN READING LOW BYTE

IF (VCC)

IODEN := MRDC * PAEN * ROM
+ IORC * PAEN * /A9 * /AB
+ INTA * PAEN
+ JXCS * PAEN
+ MWTC * PAEN
+ IOWC * PAEN
+ CMX * PAEN * IODEN

IRAM MEMORY READ
IBOARD I/O READ
INTERRUPT ACK READ
ISPECIAL SLOT READ
IALL MEMORY WRITES
IALL I/O WRITES
IHOLD ENABLE AFTER CMD GO AWAY

IF (VCC)

IODIR := MRDC * PAEN * ROM
+ IORC * PAEN * /A9 * /AB
+ INTA * PAEN
+ JXCS * PAEN
+ PAEN * IODEN * IODIR

IRAM MEMORY READ
IBOARD I/O READ
INTERRUPT ACK READ
ISPECIAL SLOT READ
IEXTEND DIR TILL ENABLE GUNE

IF (VCC)

/WAITCLK := MRDC * /IORC * /IOWC * PAEN
+ /MRDC * /IORC * /IOWC

IDONT WAIT ON CPU READS
IOR WHEN WAIT CMDS ARE INACTIVE

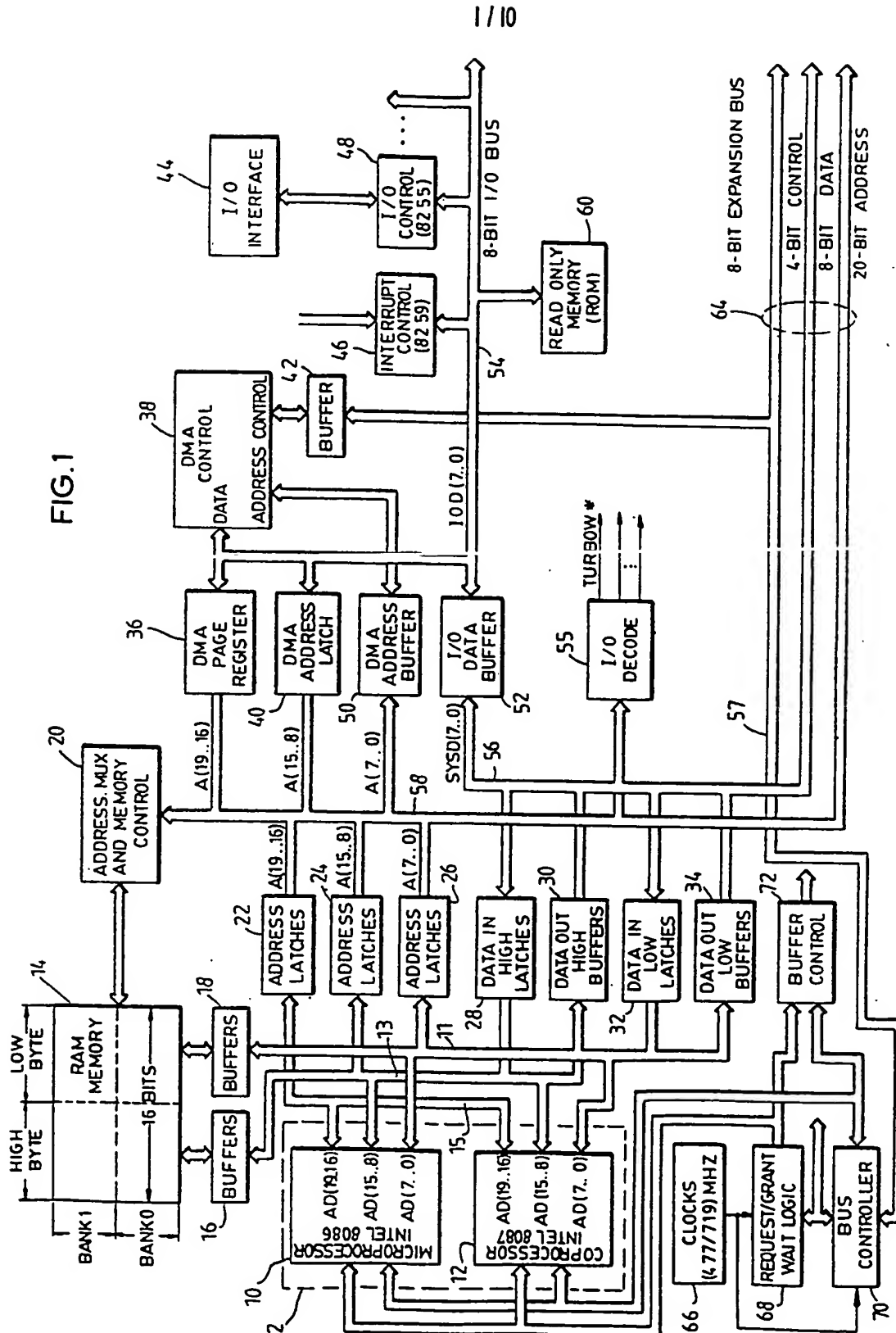
CLAIMS:

1. A personal computer having a high speed micro-processor responsive to a mode select signal for executing
5 in either a FAST mode or a SLOW mode, applications programs written for a slow speed microprocessor where the slow speed microprocessor is software compatible with said high speed microprocessor and includes an internal pre-
10 fetch queue with a first number of bytes of memory, said high speed microprocessor having an internal pre-
fetch queue with a second number of bytes of memory, said first number of bytes of pre-fetch queue less than said second number of bytes of pre-fetch queue, said computer
further including:
15
- (a) a RAM memory having each addressable memory word location characterized in that a plurality of bytes;
 - 20 (b) a clock generator responsive to the mode select signal for generating the clocking signals to said high speed microprocessor such that
 - 25 (i) in the SLOW mode, the clocking frequency is the same as the normal clocking frequency for said slow microprocessor, and
 - 30 (ii) in the FAST mode, the clocking frequency is higher than the normal clocking frequency for the slow microprocessor; and
 - 35 (c) logic means responsive to the mode select signal and said clock generator for con-

5 trolling the wait state of said high speed
microprocessor when in the SLOW speed mode
so that every other word access to said RAM
memory from said high speed microprocessor
requires two consecutive word accesses to
the same memory address to obtain the
contents of the addressed location thereby
enabling said high speed microprocessor to
execute said application programs in the
10 SLOW mode, on the average, at substantially
the same speed as the program normally runs
on said slow speed microprocessor.

15 2. The personal computer of claim 1 wherein said
logic means is characterized in that:

- 20 (a) a request/grant wait logic means for gener-
ating control signals to said high speed
microprocessor to control the wait states
thereof;
- 25 (b) a bus controller, responsive to said high
speed microprocessor and said mode select
signal for generating control signals
indicative of the cycle operations for the
high speed microprocessor; and
- 30 (c) a buffer control responsive to said
request/grant wait logic and said bus
controller for generating enable signals to
control the flow of data within said
personal computer.



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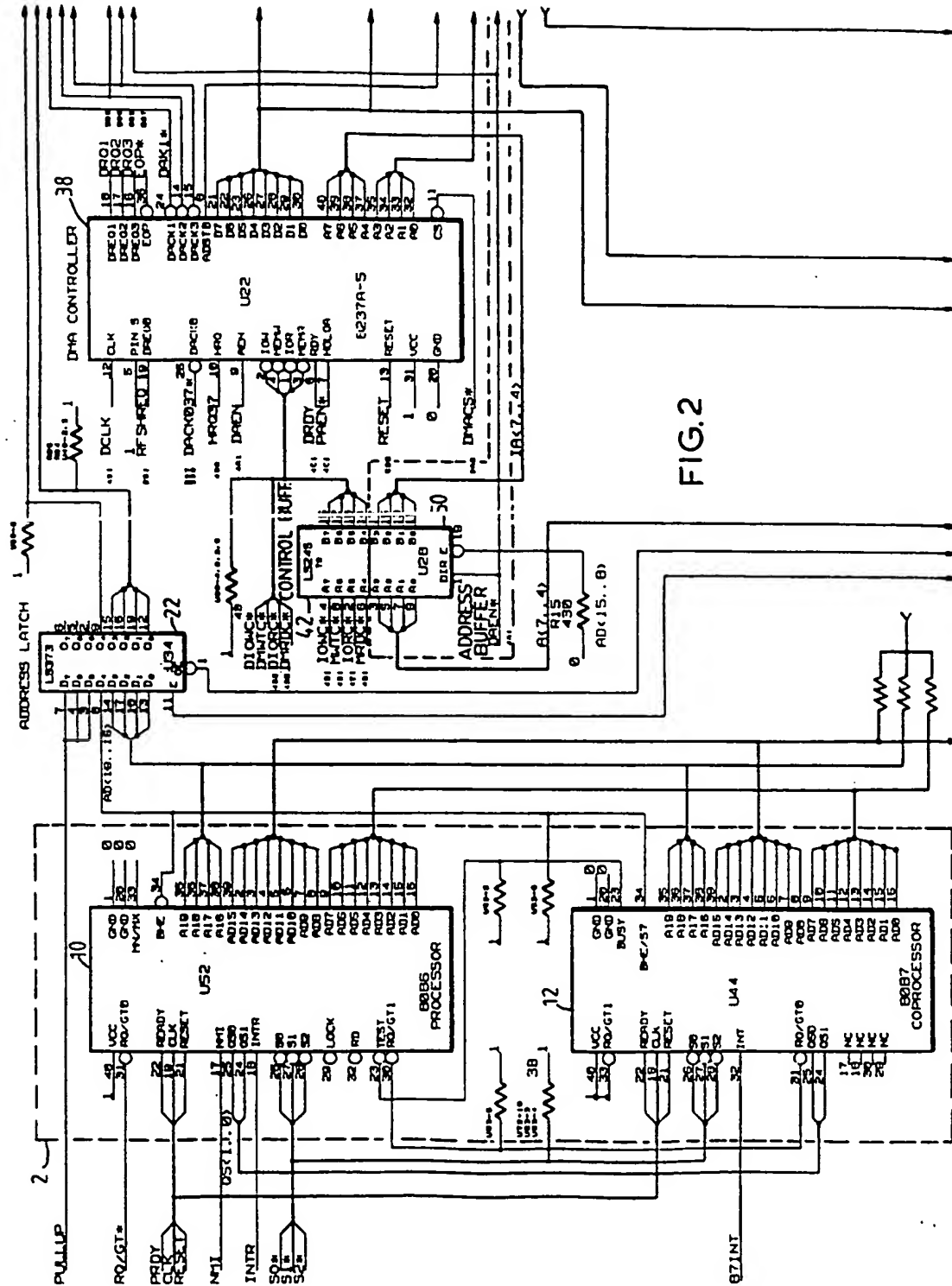


FIG. 2

FIG. 3

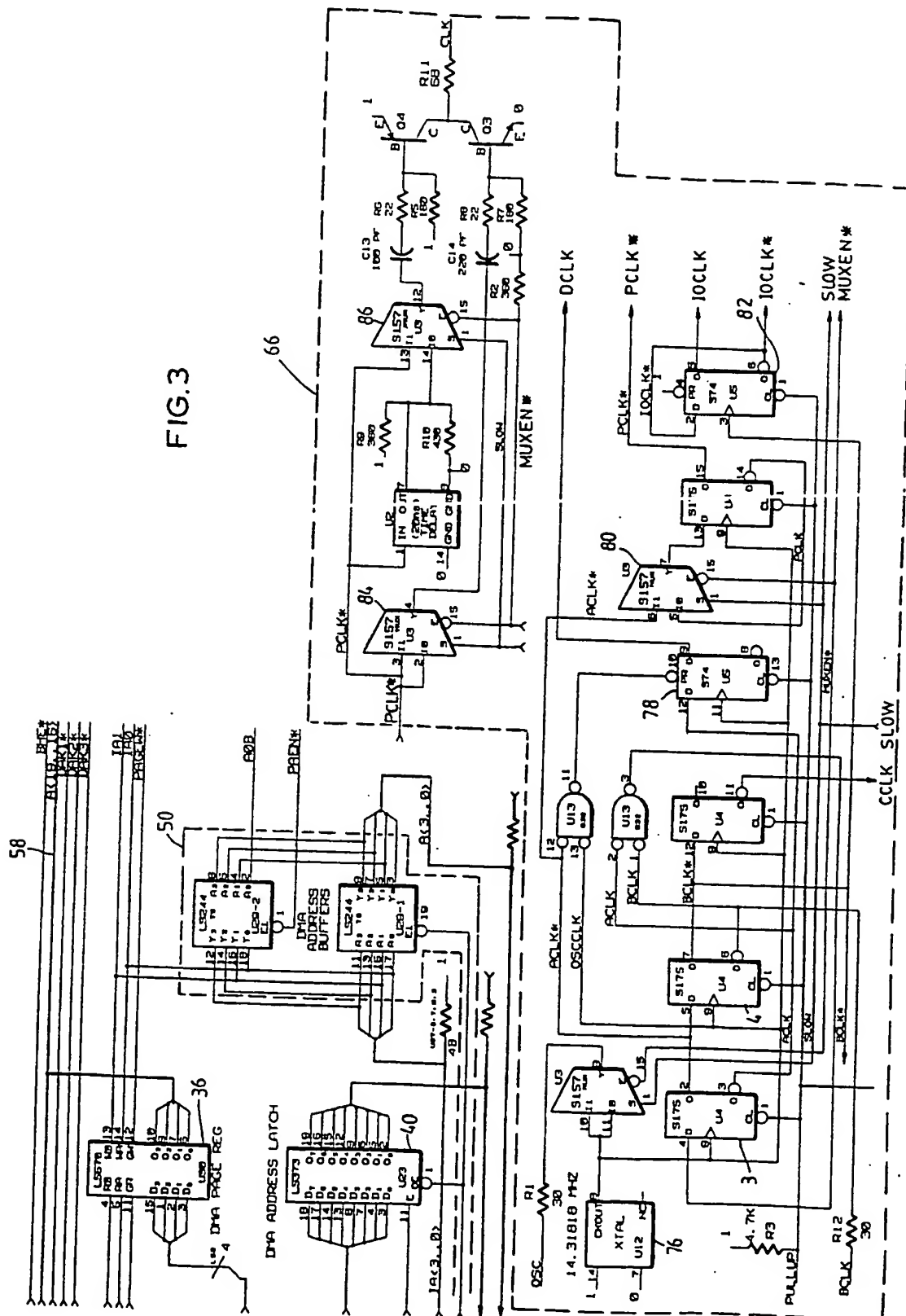
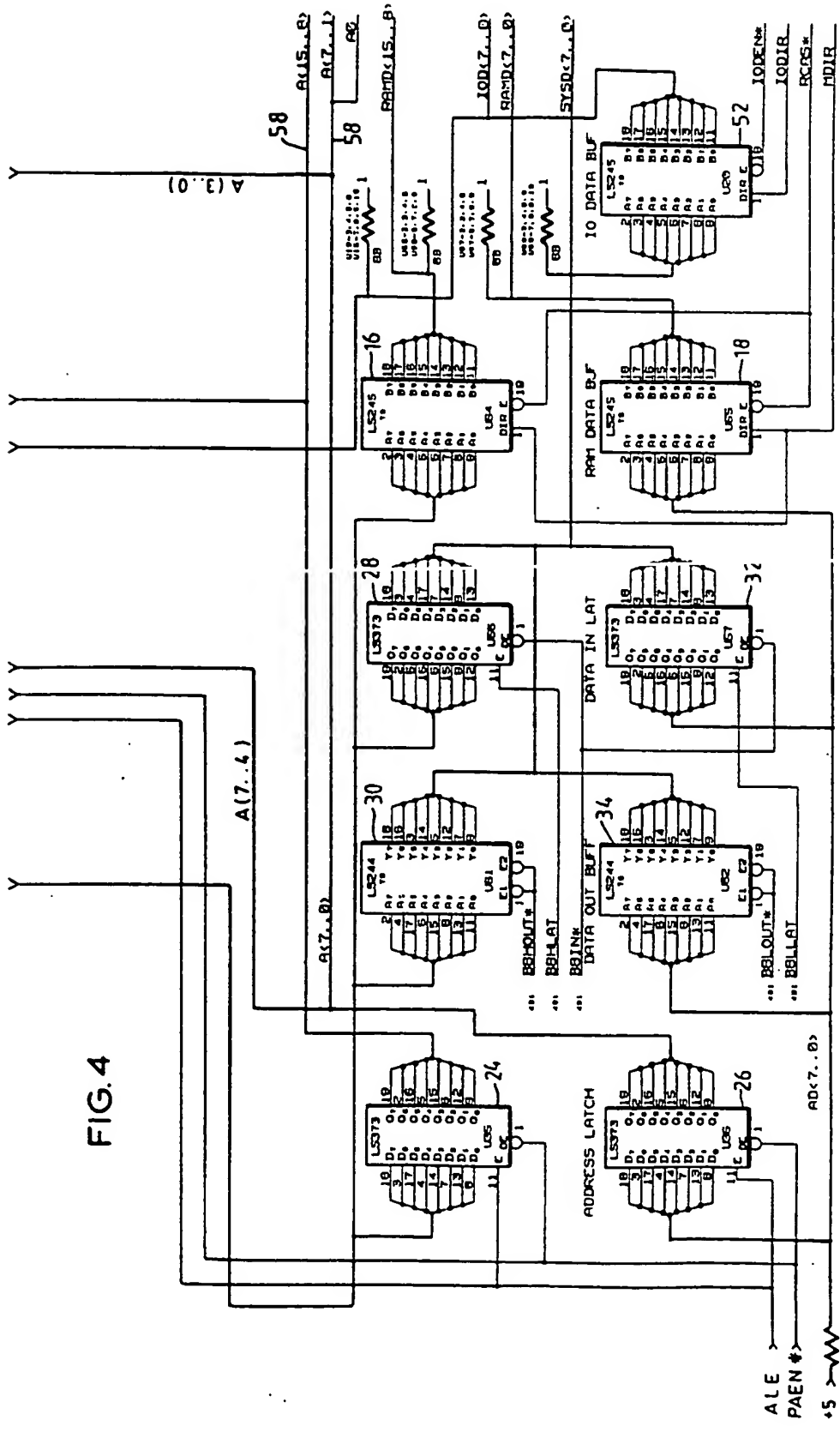


FIG. 4

The diagram illustrates a memory system architecture. It features several address buses: A(15..0) at the top, A(7..0) and A(7..4) in the middle, and A(3..0) at the bottom. Data buses are labeled RD(15..0), RD(7..0), and RD(3..0). Control signals include RD, WR, and a 10 DATA BUF. The system contains multiple memory chips: LS245 (16, 18, 24, 26, 30, 32, 34, 36), LS373 (16, 18, 24, 26, 30, 32, 34, 36), LS244 (16, 18, 24, 26, 30, 32, 34, 36), and LS374 (16, 18, 24, 26, 30, 32, 34, 36). These chips are interconnected via address and data buses. Address latches (LS373) are used to store address data. Data buffers (LS245) are used to manage data flow. The system also includes a 10 DATA BUF and a 10 DATA BUF. The diagram shows the internal structure of these chips, including address and data inputs/outputs, and their connection to the system buses.



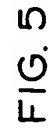
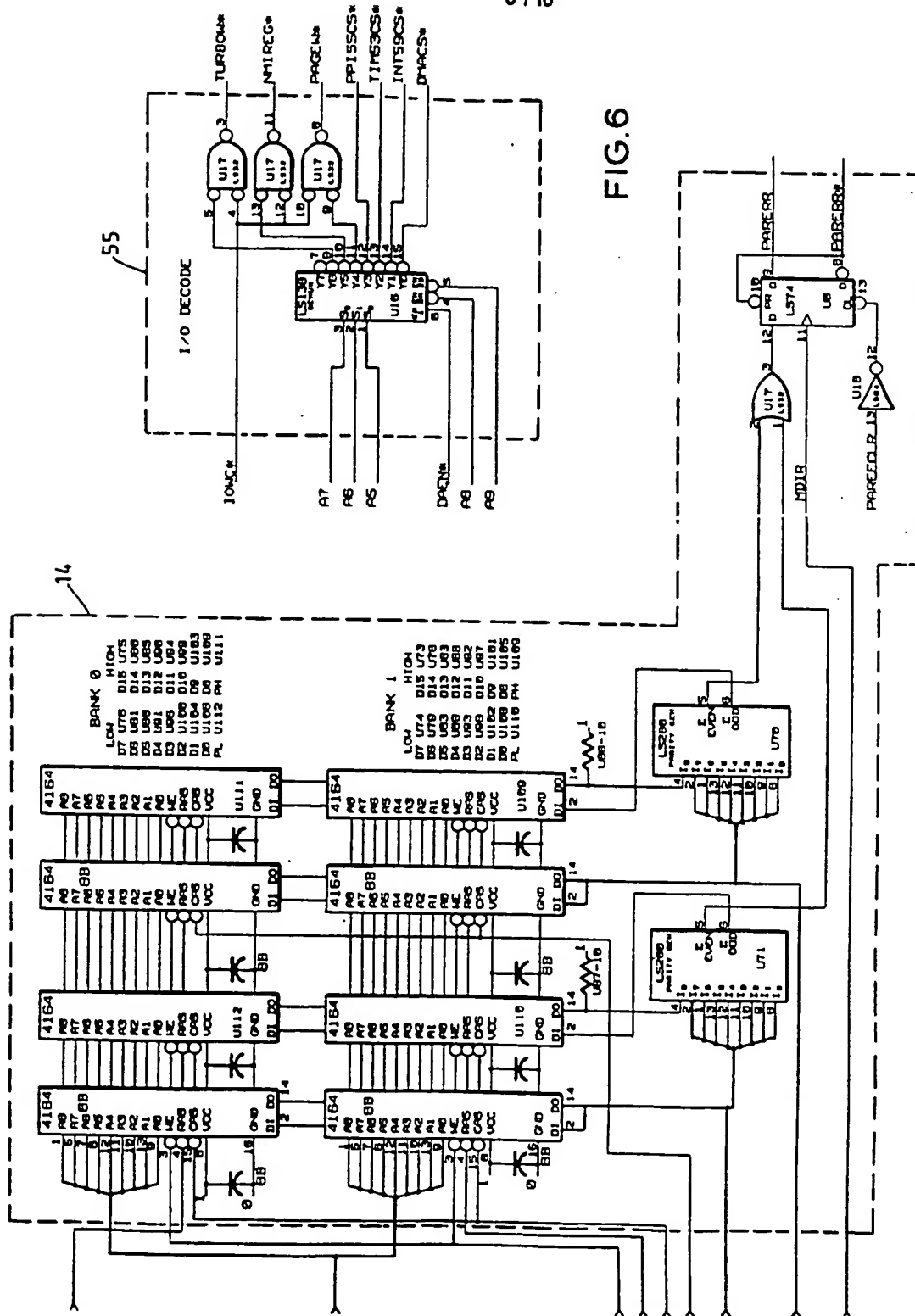


Fig. 5



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FIG. 7

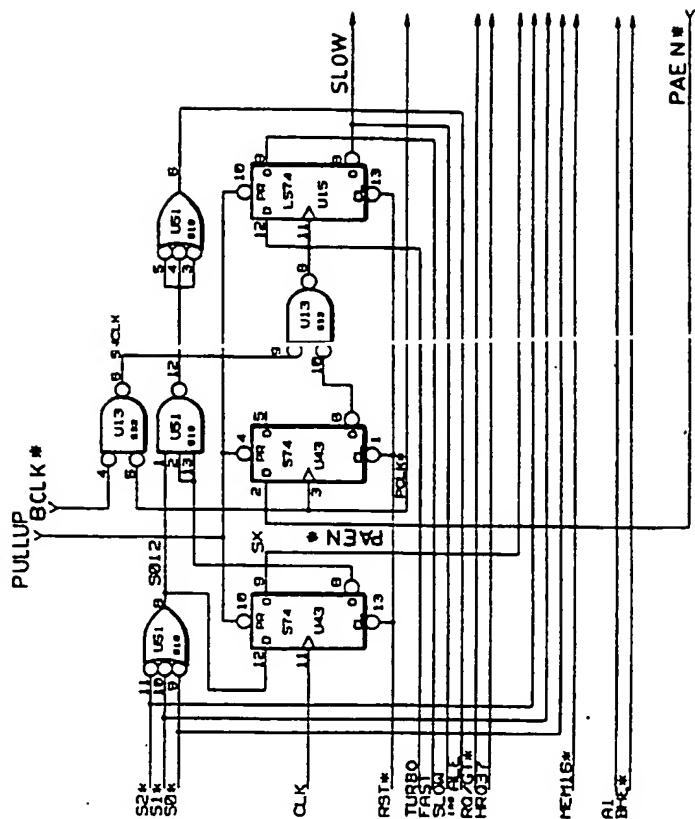
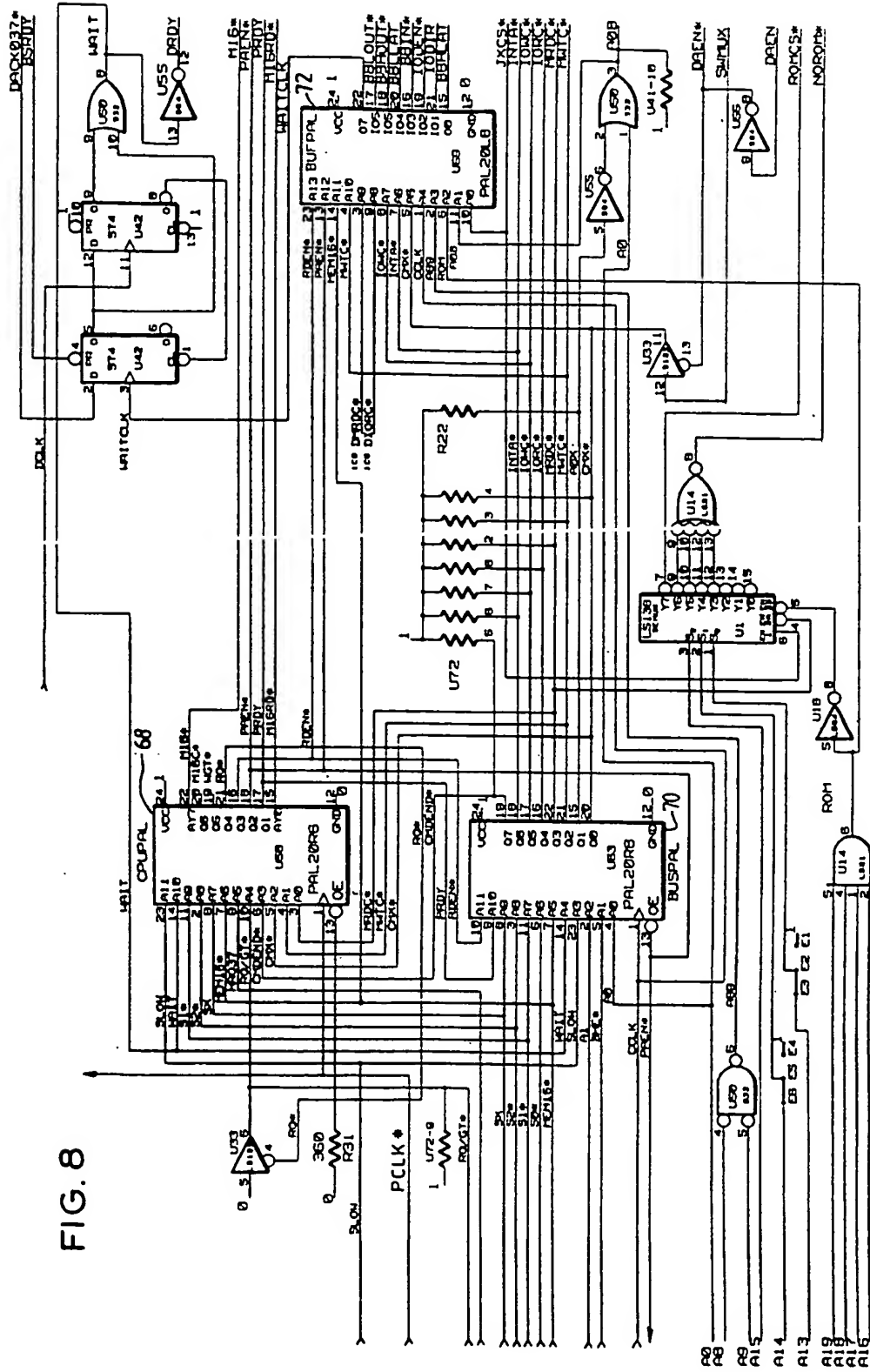


Fig. 8



(ANY OF MRDC, MWTC,
IORC, IOWC)

[illegible]

FIG.10

